Welcome to E-XFL.COM

Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	18144
Number of Logic Elements/Cells	-
Total RAM Bits	165888
Number of I/O	516
Number of Gates	1000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 85°C (TA)
Package / Case	729-BBGA
Supplier Device Package	729-PBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ax1000-1bgg729i

Figure 1-8 • **AX Routing Structures**

Global Resources

Each family member has three types of global signals available to the designer: HCLK, CLK, and GCLR/GPSET. There are four hardwired clocks (HCLK) per device that can directly drive the clock input of each R-cell. Each of the four routed clocks (CLK) can drive the clock, clear, preset, or enable pin of an R-cell or any input of a C-cell (Figure 1-3 on page 1-2).

Global clear (GCLR) and global preset (GPSET) drive the clear and preset inputs of each R-cell as well as each I/O Register on a chip-wide basis at power-up.

Each HCLK and CLK has an associated analog PLL (a total of eight per chip). Each embedded PLL can be used for clock delay minimization, clock delay adjustment, or clock frequency synthesis. The PLL is capable of operating with input frequencies ranging from 14 MHz to 200 MHz and can generate output frequencies between 20 MHz and 1 GHz. The clock can be either divided or multiplied by factors ranging from 1 to 64. Additionally, multiply and divide settings can be used in any combination as long as the resulting clock frequency is between 20 MHz and 1 GHz. Adjacent PLLs can be cascaded to create complex frequency combinations.

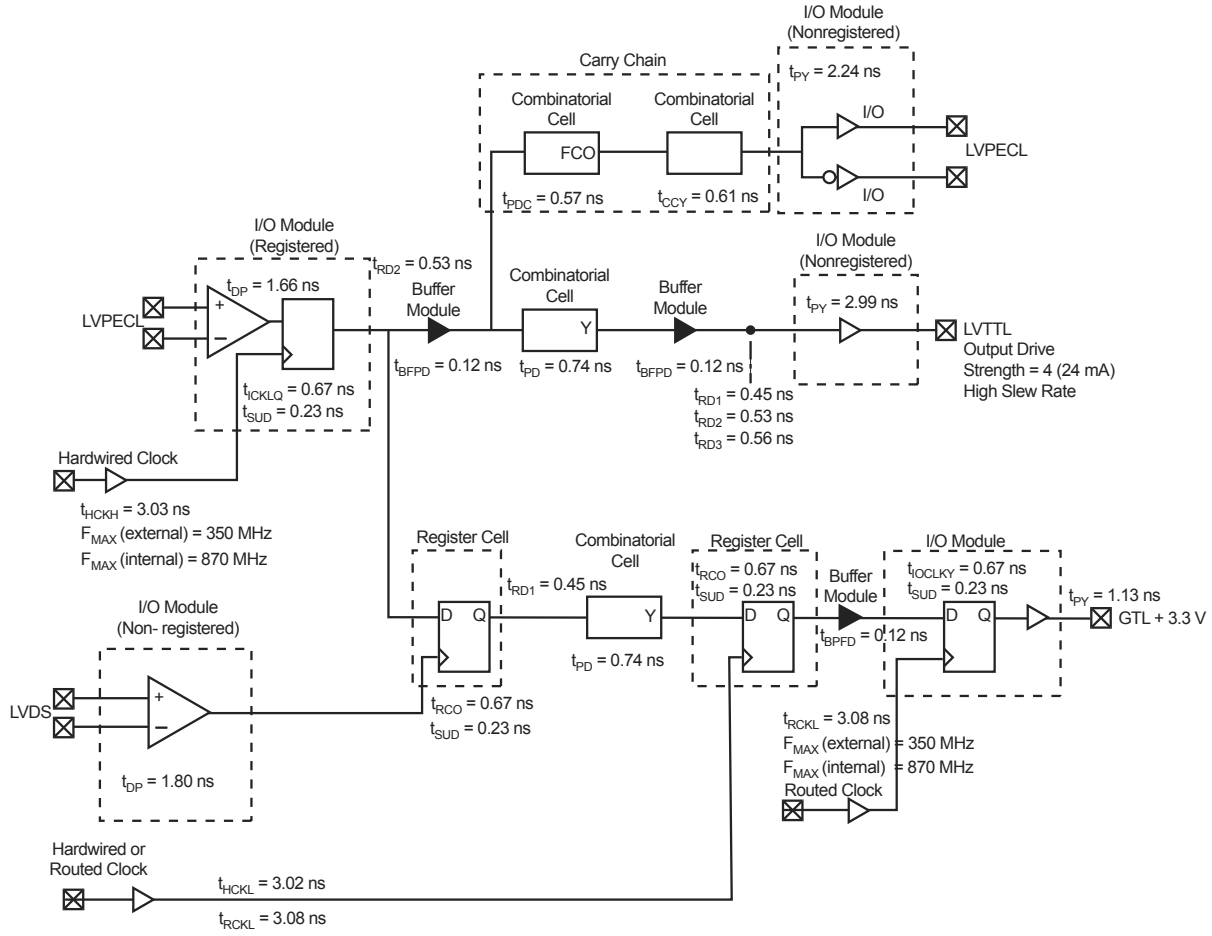
The PLL can be used to introduce either a positive or a negative clock delay of up to 3.75 ns in 250 ps increments. The reference clock required to drive the PLL can be derived from three sources: external input pad (either single-ended or differential), internal logic, or the output of an adjacent PLL.

Low Power (LP) Mode

The AX architecture was created for high-performance designs but also includes a low power mode (activated via the LP pin). When the low power mode is activated, I/O banks can be disabled (inputs disabled, outputs tristated), and PLLs can be placed in a power-down mode. All internal register states are maintained in this mode. Furthermore, individual I/O banks can be configured to opt out of the LP mode, thereby giving the designer access to critical signals while the rest of the chip is in low power mode.

The power can be further reduced by providing an external voltage source (V_{PUMP}) to the device to bypass the internal charge pump (See "Low Power Mode" on page 2-106 for more information).

Timing Model



Note: Worst case timing data for the AX1000, –2 speed grade

Figure 2-1 • **Worst Case Timing Data**

Hardwired Clock – Using LVTTL 24 mA High Slew Clock I/O

External Setup

$= (t_{DP} + t_{RD2} + t_{SUD}) – t_{HCKL}$

$= (1.72 + 0.53 + 0.23) – 3.02 = –0.54$ ns

Clock-to-Out (Pad-to-Pad)

$= t_{HCKL} + t_{RCO} + t_{RD1} + t_{PY}$

$= 3.02 + 0.67 + 0.45 + 2.99 = 7.13$ ns

Routed Clock – Using LVTTL 24 mA High Slew Clock I/O

External Setup

$= (t_{DP} + t_{RD2} + t_{SUD}) – t_{RCKH}$

$= (1.72 + 0.53 + 0.23) – 3.13 = –0.65$ ns

Clock-to-Out (Pad-to-Pad)

$= t_{RCKH} + t_{RCO} + t_{RD1} + t_{PY}$

$= 3.13 + 0.67 + 0.45 + 3.03 = 7.24$ ns

***Table 2-57* • AC Waveforms, Measuring Points, and Capacitive Loads**

Input Low (V)	Input High (V)	Measuring Point* (V)
1.2 – 0.125	1.2 + 0.125	1.2

*Note: * Measuring Point = VTRIP*

Timing Characteristics

***Table 2-58* • LVDS I/O Module**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 2.3 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
LVDS Output Module Timing								
t_{DP}	Input Buffer		1.80		2.05		2.41	ns
t_{PY}	Output Buffer		2.32		2.64		3.11	ns
t_{ICLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t_{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t_{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t_{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t_{HD}	Data Input Hold		0.00		0.00		0.00	ns
t_{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t_{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t_{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t_{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t_{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t_{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t_{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t_{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Module Specifications

C-Cell

Introduction

The C-cell is one of the two logic module types in the AX architecture. It is the combinatorial logic resource in the Axcelerator device. The AX architecture implements a new combinatorial cell that is an extension of the C-cell implemented in the SX-A family. The main enhancement of the new C-cell is the addition of carry-chain logic.

The C-cell can be used in a carry-chain mode to construct arithmetic functions. If carry-chain logic is not required, it can be disabled.

The C-cell features the following (Figure 2-27):

- Eight-input MUX (data: D0-D3, select: A0, A1, B0, B1). User signals can be routed to any one of these inputs. Any of the C-cell inputs (D0-D3, A0, A1, B0, B1) can be tied to one of the four routed clocks (CLKE/F/G/H).
- Inverter (DB input) can be used to drive a complement signal of any of the inputs to the C-cell.
- A carry input and a carry output. The carry input signal of the C-cell is the carry output from the C-cell directly to the north.
- Carry connect for carry-chain logic with a signal propagation time of less than 0.1 ns.
- A hardwired connection (direct connect) to the adjacent R-cell (Register Cell) for all C-cells on the east side of a SuperCluster with a signal propagation time of less than 0.1 ns.

This layout of the C-cell (and the C-cell Cluster) enables the implementation of over 4,000 functions of up to five bits. For example, two C-cells can be used together to implement a four-input XOR function in a single cell delay.

The carry-chain configuration is handled automatically for the user with Microsemi's extensive macro library (please see the *Antifuse Macro Library Guide* for a complete listing of available Axcelerator macros).

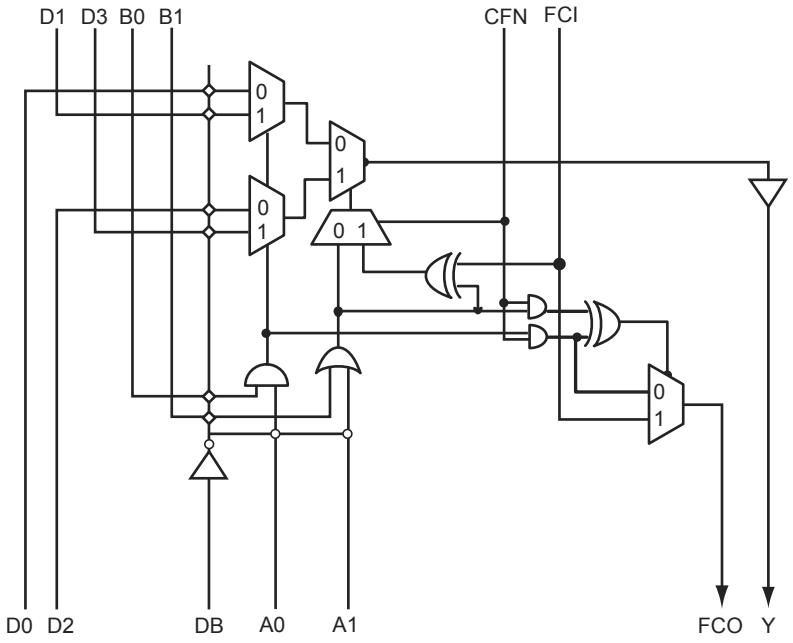


Figure 2-27 • **C-Cell**

Axcelerator Clock Management System

Introduction

Each member of the Axcelerator family[6] contains eight phase-locked loop (PLL) blocks which perform the following functions:

- Programmable Delay (32 steps of 250 ps)
- Clock Skew Minimization
- Clock Frequency Synthesis

Each PLL has the following key features:

- Input Frequency Range – 14 to 200 MHz
- Output Frequency Range – 20 MHz to 1 GHz
- Output Duty Cycle Range – 45% to 55%
- Maximum Long-Term Jitter – 1% or 100ps (whichever is greater)
- Maximum Short-Term Jitter – 50ps + 1% of Output Frequency
- Maximum Acquisition Time (lock) – 20µs

Physical Implementation

The eight PLL blocks are arranged in two groups of four. One group is located in the center of the northern edge of the chip, while the second group is centered on the southern edge. The northern group is associated with the four HCLK networks (e.g. PLLA can drive HCLKA), while the southern group is associated with the four CLK networks (e.g. PLLE can drive CLKE).

Each PLL cell is connected to two I/O pads and a PLL Cluster that interfaces with the FPGA core. Figure 2-48 illustrates a PLL block. The VCCPLL pin should be connected to a 1.5V power supply through a 250 Ω resistor. Furthermore, 0.1 µF and 10 µF decoupling capacitors should be connected across the VCCPLL and VCOMPPLL pins.

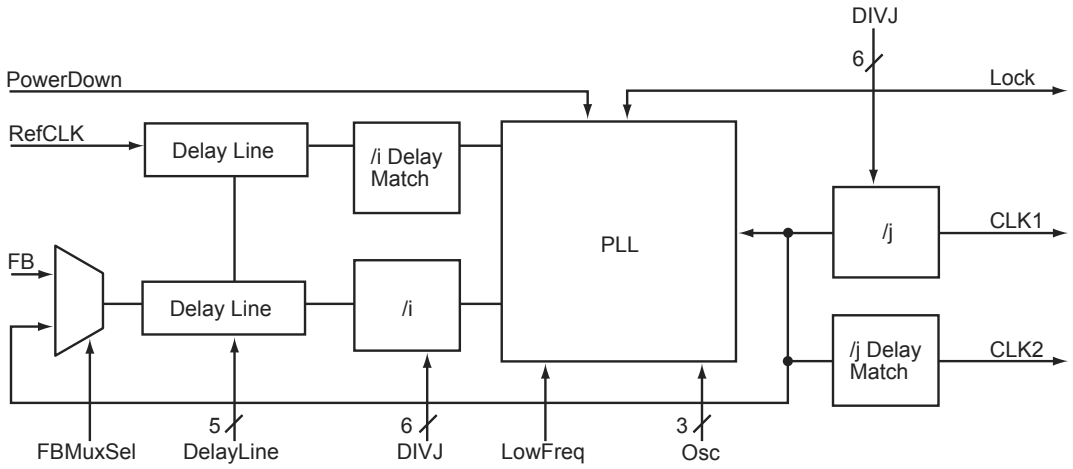


Figure 2-48 • **PLL Block Diagram**

Note: The VCOMPPLL pin should never be grounded (Figure 2-2 on page 2-9)!

The I/O pads associated with the PLL can also be configured for regular I/O functions except when it is used as a clock buffer. The I/O pads can be configured in all the modes available to the regular I/O pads in the same I/O bank. In particular, the [H]CLKxP pad can be configured as a differential pair,

6. *AX2000-CQ256 does not support operation of the phase-locked loops. This is in order to support full pin compatibility with RTAX2000S/SL-CQ256.*

***Table 2-100* • Four FIFO Blocks Cascaded**
Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	**Description**	**Min.**	**Max.**	**Min.**	**Max.**	**Min.**	**Max.**	**Units**
FIFO Module Timing								
t_{WSU}	Write Setup		14.60		16.63		19.55	ns
t_{WHD}	Write Hold		0.00		0.00		0.00	ns
t_{WCKH}	WCLK High		0.75		0.75		0.75	ns
t_{WCKL}	WCLK Low		2.51		2.51		2.51	ns
t_{WCKP}	Minimum WCLK Period	3.26		3.26		3.26		ns
t_{RSU}	Read Setup		15.27		17.39		20.44	ns
t_{RHD}	Read Hold		0.00		0.00		0.00	ns
t_{RCKH}	RCLK High		0.73		0.73		0.73	ns
t_{RCKL}	RCLK Low		2.96		2.96		2.96	ns
t_{RCKP}	Minimum RCLK period	3.69		3.69		3.69		ns
t_{CLRHF}	Clear High		0.00		0.00		0.00	ns
t_{CLR2FF}	Clear-to-flag (EMPTY/FULL)		1.92		2.18		2.57	ns
t_{CLR2AF}	Clear-to-flag (AEMPTY/AFULL)		4.39		5.00		5.88	ns
t_{CK2FF}	Clock-to-flag (EMPTY/FULL)		2.13		2.42		2.85	ns
t_{CK2AF}	Clock-to-flag (AEMPTY/AFULL)		5.04		5.75		6.75	ns
$t_{RCK2RD1}$	RCLK-To-OUT (Pipelined)		2.36		2.69		3.16	ns
$t_{RCK2RD2}$	RCLK-To-OUT (Nonpipelined)		2.83		3.23		3.79	ns

Note: Timing data for these four cascaded FIFO blocks uses a depth of 16,384. For all other combinations, use Microsemi's timing software.

mode if desired. Please note, if the I/O bank is not disabled, differential I/Os belonging to the I/O bank will still consume normal power, even when operating in the low power mode.

The Axcelerator device will resume normal operation 10µs after the LP pin is pulled Low.

To further reduce power consumption, the internal charge pump can be bypassed and an external power supply voltage can be used instead. This saves the internal charge-pump operating current, resulting in no DC current draw. The Axcelerator family devices have a dedicated "V_{PUMP}" pin that can be used to access an external charge pump device. In normal chip operation, when using the internal charge pump, V_{PUMP} should be tied to GND. When the voltage level on V_{PUMP} is set to 3.3V, the internal charge pump is turned off, and the V_{PUMP} voltage will be used as the charge pump voltage. Adequate voltage regulation (i.e. high drive, low output impedance, and good decoupling) should be used at V_{PUMP}.

In addition, any PLL in use can be powered down to further reduce power consumption. This can be done with the PowerDown pin driven Low. Driving this pin High restarts the PLL with the output clock(s) being stable once lock is restored.

JTAG

Axcelerator offers a JTAG interface that is compliant with the IEEE 1149.1 standard. The user can employ the JTAG interface for probing a design and performing any JTAG Public Instructions as defined in the Table 2-103.

***Table 2-103* • JTAG Instruction Code**

Instruction (IR4:IR0)	Binary Code
Extest	00000
Preload / Sample	00001
Intest	00010
USERCODE	00011
IDCODE	00100
HIGHZ	01110
CLAMP	01111
Diagnostic	10000
Reserved	All others
Bypass	11111

Interface

The interface consists of four inputs: Test Mode Select (TMS), Test Data In (TDI), Test Clock (TCK), TAP Controller Reset (TRST), and an output, Test Data Out (TDO). TMS, TDI, and TRST have on-chip pull-up resistors.

TRST

TRST (Test-Logic Reset) is an active-low, asynchronous reset signal to the TAP controller. The TRST input can be used to reset the Test Access Port (TAP) Controller to the TRST state. The TAP Controller can be held at this state permanently by grounding the TRST pin. To hold the JTAG TAP controller in the TRST state, it is recommended to connect TRST to ground via a 1 kΩ resistor.

There is an optional internal pull-up resistor available for the TRST input that can be set by the user at programming. Care should be exercised when using this option in combination with an external tie-off to ground.

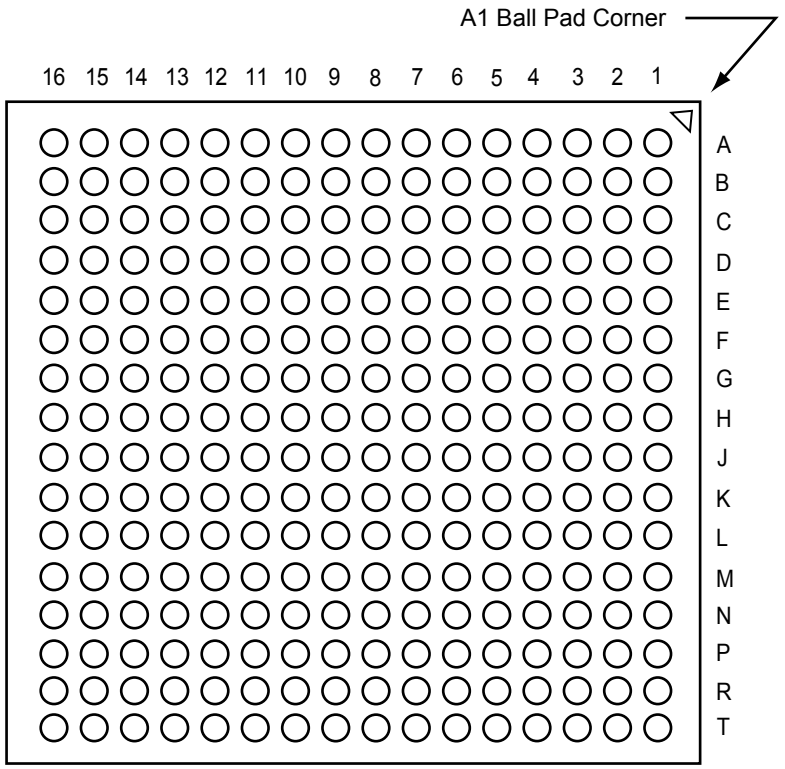
An on-chip power-on-reset (POWRST) circuit is included. POWRST has the same function as "TRST," but it only occurs at power-up or during recovery from a VCCA and/or VCCDA voltage drop.

BG729	
AX1000 Function	Pin Number
IO218PB6F20	V2
IO219NB6F20	T1
IO219PB6F20	U1
IO220NB6F20	R5
IO220PB6F20	R6
IO221NB6F20	T3
IO221PB6F20	T4
IO222NB6F20	R2
IO222PB6F20	T2
IO223NB6F20	P8
IO223PB6F20	P9
IO224NB6F20	R3
IO224PB6F20	R4
Bank 7	
IO225NB7F21	P1
IO225PB7F21	R1
IO226NB7F21	P3
IO226PB7F21	P2
IO227NB7F21	N7
IO227PB7F21	P7
IO228NB7F21	P5
IO228PB7F21	P4
IO229NB7F21	N2
IO229PB7F21	N1
IO230NB7F21	N6
IO230PB7F21	P6
IO231NB7F21	N9
IO231PB7F21	N8
IO232NB7F21	N4
IO232PB7F21	N3
IO233NB7F21	M2
IO233PB7F21	M1
IO234NB7F21	M4
IO234PB7F21	M3
IO235NB7F21	M5
IO235PB7F21	N5
IO236NB7F22	L2

BG729	
AX1000 Function	Pin Number
IO236PB7F22	L1
IO237NB7F22	L4
IO237PB7F22	L3
IO238NB7F22	L6
IO238PB7F22	M6
IO239NB7F22	M8
IO239PB7F22	M7
IO240NB7F22	K2
IO240PB7F22	K1
IO241NB7F22	K4
IO241PB7F22	K3
IO242NB7F22	K5
IO242PB7F22	L5
IO243NB7F22	J2
IO243PB7F22	J1
IO244NB7F22	J4
IO244PB7F22	J3
IO245NB7F22	H2
IO245PB7F22	H1
IO246NB7F22	H4
IO246PB7F22	H3
IO247NB7F23	L8
IO247PB7F23	L7
IO248NB7F23	J6
IO248PB7F23	K6
IO249NB7F23	H5
IO249PB7F23	J5
IO250NB7F23	G2
IO250PB7F23	G1
IO251NB7F23	K8
IO251PB7F23	K7
IO252NB7F23	G4
IO252PB7F23	G3
IO253NB7F23	F2
IO253PB7F23	F1
IO254NB7F23	G6
IO254PB7F23	H6

BG729	
AX1000 Function	Pin Number
IO255NB7F23	F5
IO255PB7F23	G5
IO256NB7F23	F3
IO256PB7F23	F4
IO257NB7F23	H7
IO257PB7F23	J7
Dedicated I/O	
GND	A1
GND	A2
GND	A25
GND	A26
GND	A27
GND	A3
GND	AC24
GND	AE1
GND	AE2
GND	AE25
GND	AE26
GND	AE27
GND	AE3
GND	AE5
GND	AF1
GND	AF2
GND	AF25
GND	AF26
GND	AF27
GND	AF3
GND	AG1
GND	AG2
GND	AG25
GND	AG26
GND	AG27
GND	AG3
GND	B1
GND	B2
GND	B25
GND	B26

FG256



Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.microsemi.com/soc/products/rescenter/package/index.html.

FG484	
AX500 Function	**Pin Number**
IO163NB7F15	G5
IO163PB7F15	G6
IO164NB7F15	D1
IO164PB7F15	E1
IO165NB7F15	F4
IO165PB7F15	G4
IO166NB7F15	D2
IO166PB7F15	E2
IO167NB7F15	F5
IO167PB7F15	E4
Dedicated I/O	
VCCDA	H7
GND	A1
GND	A11
GND	A12
GND	A2
GND	A21
GND	A22
GND	AA1
GND	AA2
GND	AA21
GND	AA22
GND	AB1
GND	AB11
GND	AB12
GND	AB2
GND	AB21
GND	AB22
GND	B1
GND	B2
GND	B21
GND	B22
GND	C20
GND	C3
GND	D19

FG484	
AX500 Function	**Pin Number**
GND	D4
GND	E18
GND	E5
GND	G18
GND	H15
GND	H8
GND	J14
GND	J9
GND	K10
GND	K11
GND	K12
GND	K13
GND	L1
GND	L10
GND	L11
GND	L12
GND	L13
GND	L22
GND	M1
GND	M10
GND	M11
GND	M12
GND	M13
GND	M22
GND	N10
GND	N11
GND	N12
GND	N13
GND	P14
GND	P9
GND	R15
GND	R8
GND	U16
GND	U6
GND	V18

FG484	
AX500 Function	**Pin Number**
GND	V5
GND	W19
GND	W4
GND	Y20
GND	Y3
GND/LP	G7
NC	AB8
NC	AB16
NC	C10
NC	C11
NC	C14
PRA	G11
PRB	F11
PRC	T12
PRD	U12
TCK	G8
TDI	F9
TDO	F7
TMS	F6
TRST	F8
VCCA	G17
VCCA	J10
VCCA	J11
VCCA	J12
VCCA	J13
VCCA	J7
VCCA	K14
VCCA	K9
VCCA	L14
VCCA	L9
VCCA	M14
VCCA	M9
VCCA	N14
VCCA	N9
VCCA	P10

FG484	
AX1000 Function	Pin Number
IO167PB5F15	AA12
IO169NB5F15	AA9
IO169PB5F15	AA10
IO170NB5F15	AB9
IO170PB5F15	AB10
IO171NB5F16	W8
IO171PB5F16	W9
IO172NB5F16	Y8
IO172PB5F16	Y9
IO173NB5F16	U8
IO173PB5F16	U9
IO174NB5F16	AA7
IO174PB5F16	AA8
IO175NB5F16	AB5
IO175PB5F16	AB6
IO176NB5F16	AA5
IO176PB5F16	AA6
IO177NB5F16	AA4
IO177PB5F16	AB4
IO178NB5F16	Y6
IO178PB5F16	Y7
IO179NB5F16	T7
IO179PB5F16	T8
IO180NB5F16	W6
IO180PB5F16	W7
IO181NB5F17	Y4
IO181PB5F17	Y5
IO184NB5F17	AB7
IO187NB5F17	V3
IO187PB5F17	W3
IO188NB5F17	V4
IO188PB5F17	W5
IO192NB5F17	V6
IO192PB5F17	V7
Bank 6	

FG484	
AX1000 Function	Pin Number
IO194NB6F18	V2
IO194PB6F18	W2
IO195NB6F18	U5
IO195PB6F18	T5
IO200NB6F18	T4
IO200PB6F18	U4
IO201NB6F18	P6
IO201PB6F18	R6
IO203NB6F19	U2
IO204NB6F19	T3
IO204PB6F19	U3
IO205NB6F19	P5
IO205PB6F19	R5
IO208NB6F19	V1
IO208PB6F19	W1
IO209NB6F19	P7
IO209PB6F19	R7
IO212NB6F19	P4
IO212PB6F19	R4
IO214NB6F20	P3
IO214PB6F20	R3
IO215NB6F20	M6
IO215PB6F20	N6
IO216NB6F20	R2
IO216PB6F20	T2
IO217NB6F20	T1
IO217PB6F20	U1
IO219NB6F20	M5
IO219PB6F20	N5
IO220NB6F20	P1
IO220PB6F20	R1
IO221NB6F20	N2
IO221PB6F20	P2
IO222NB6F20	M3
IO222PB6F20	N3

FG484	
AX1000 Function	Pin Number
IO223NB6F20	M7
IO223PB6F20	N7
IO224NB6F20	M4
IO224PB6F20	N4
Bank 7	
IO225NB7F21	M2
IO225PB7F21	N1
IO226NB7F21	K2
IO226PB7F21	K1
IO228NB7F21	L3
IO228PB7F21	L2
IO229NB7F21	K5
IO229PB7F21	L5
IO230NB7F21	H1
IO230PB7F21	J1
IO231NB7F21	H2
IO231PB7F21	J2
IO232NB7F21	K4
IO232PB7F21	K3
IO233NB7F21	K6
IO233PB7F21	L6
IO234NB7F21	F1
IO234PB7F21	G1
IO235NB7F21	F2
IO235PB7F21	G2
IO236NB7F22	H3
IO236PB7F22	J3
IO237NB7F22	K7
IO237PB7F22	L7
IO241NB7F22	H6
IO241PB7F22	J6
IO242NB7F22	H4
IO242PB7F22	J4
IO243NB7F22	H5
IO243PB7F22	J5

FG896	
AX1000 Function	Pin Number
NC	K1
NC	K2
NC	L30
NC	M30
NC	N29
NC	T1
NC	U1
NC	W30
NC	Y1
NC	Y2
NC	Y30
PRA	G15
PRB	D16
PRC	AB16
PRD	AF16
TCK	G7
TDI	D5
TDO	J8
TMS	F6
TRST	C4
VCCA	AD6
VCCA	AH26
VCCA	E28
VCCA	E3
VCCA	L12
VCCA	L13
VCCA	L14
VCCA	L15
VCCA	L16
VCCA	L17
VCCA	L18
VCCA	L19
VCCA	M11
VCCA	M20
VCCA	N11

FG896	
AX1000 Function	Pin Number
VCCA	N20
VCCA	P11
VCCA	P20
VCCA	R11
VCCA	R20
VCCA	T11
VCCA	T20
VCCA	U11
VCCA	U20
VCCA	V11
VCCA	V20
VCCA	W11
VCCA	W20
VCCA	Y12
VCCA	Y13
VCCA	Y14
VCCA	Y15
VCCA	Y16
VCCA	Y17
VCCA	Y18
VCCA	Y19
VCCPLA	G14
VCCPLB	H15
VCCPLC	G17
VCCPLD	J16
VCCPLE	AH17
VCCPLF	AC16
VCCPLG	AH14
VCCPLH	AD15
VCCDA	AD24
VCCDA	AD7
VCCDA	AF12
VCCDA	AF13
VCCDA	AF15
VCCDA	AF18

FG896	
AX1000 Function	Pin Number
VCCDA	AF19
VCCDA	C13
VCCDA	C5
VCCDA	D13
VCCDA	D19
VCCDA	D3
VCCDA	E18
VCCDA	F26
VCCDA	G16
VCCDA	T25
VCCDA	T4
VCCIB0	A3
VCCIB0	B3
VCCIB0	J10
VCCIB0	J11
VCCIB0	J12
VCCIB0	K11
VCCIB0	K12
VCCIB0	K13
VCCIB0	K14
VCCIB0	K15
VCCIB1	A28
VCCIB1	B28
VCCIB1	J19
VCCIB1	J20
VCCIB1	J21
VCCIB1	K16
VCCIB1	K17
VCCIB1	K18
VCCIB1	K19
VCCIB1	K20
VCCIB2	C29
VCCIB2	C30
VCCIB2	K22
VCCIB2	L21

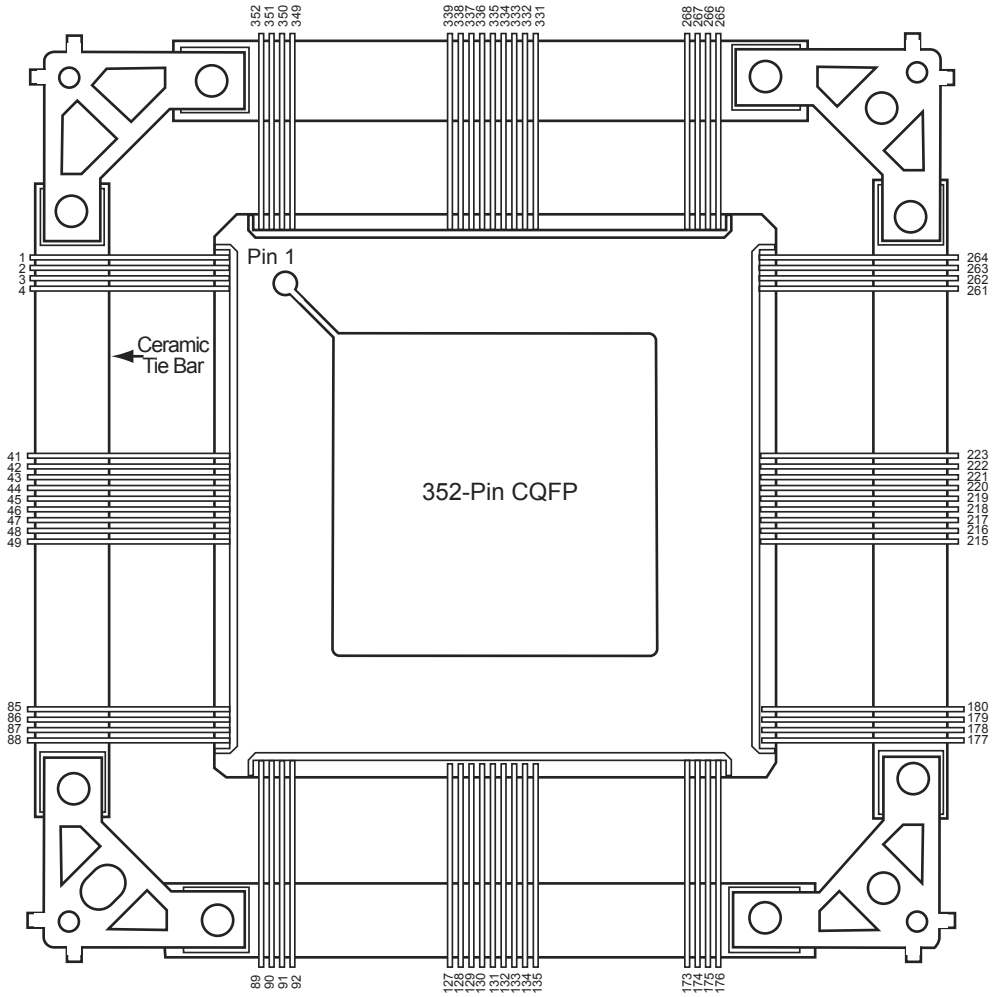
FG1152	
AX2000 Function	**Pin Number**
VCOMPLD	K18
VCOMPLE	AH19
VCOMPLF	AF18
VCOMPLG	AH16
VCOMPLH	AD17
VPUMP	J26

CQ208	
AX250 Function	Pin Number
Bank 0	
IO02NB0F0	197
IO03NB0F0	198
IO03PB0F0	199
IO12NB0F0/HCLKAN	191
IO12PB0F0/HCLKAP	192
IO13NB0F0/HCLKBN	185
IO13PB0F0/HCLKBP	186
Bank 1	
IO14NB1F1/HCLKCN	180
IO14PB1F1/HCLKCP	181
IO15NB1F1/HCLKDN	174
IO15PB1F1/HCLKDP	175
IO16NB1F1	170
IO16PB1F1	171
IO24NB1F1	165
IO24PB1F1	166
IO26NB1F1	161
IO26PB1F1	162
IO27NB1F1	159
IO27PB1F1	160
Bank 2	
IO29NB2F2	151
IO29PB2F2	153
IO30NB2F2	152
IO30PB2F2	154
IO31PB2F2	148
IO32NB2F2	146
IO32PB2F2	147
IO34NB2F2	144
IO34PB2F2	145
IO39NB2F2	139
IO39PB2F2	140
IO40PB2F2	141
IO41NB2F2	137
IO41PB2F2	138
IO43NB2F2	132

CQ208	
AX250 Function	Pin Number
IO43PB2F2	134
IO44NB2F2	131
IO44PB2F2	133
Bank 3	
IO45NB3F3	127
IO45PB3F3	129
IO46NB3F3	126
IO46PB3F3	128
IO48NB3F3	122
IO48PB3F3	123
IO50NB3F3	120
IO50PB3F3	121
IO55NB3F3	116
IO55PB3F3	117
IO57NB3F3	114
IO57PB3F3	115
IO59NB3F3	110
IO59PB3F3	111
IO60NB3F3	108
IO60PB3F3	109
IO61NB3F3	106
IO61PB3F3	107
Bank 4	
IO62NB4F4	100
IO62PB4F4	103
IO63NB4F4	101
IO63PB4F4	102
IO64NB4F4	96
IO64PB4F4	97
IO72NB4F4	91
IO72PB4F4	92
IO74NB4F4/CLKEN	87
IO74PB4F4/CLKEP	88
IO75NB4F4/CLKFN	81
IO75PB4F4/CLKFP	82
Bank 5	
IO76NB5F5/CLKGN	76

CQ208	
AX250 Function	Pin Number
IO76PB5F5/CLKGP	77
IO77NB5F5/CLKHN	70
IO77PB5F5/CLKHP	71
IO78NB5F5	66
IO78PB5F5	67
IO86NB5F5	62
IO87NB5F5	60
IO87PB5F5	61
IO88NB5F5	56
IO88PB5F5	57
IO89NB5F5	54
IO89PB5F5	55
Bank 6	
IO91NB6F6	47
IO91PB6F6	49
IO92NB6F6	48
IO92PB6F6	50
IO93NB6F6	42
IO93PB6F6	43
IO94PB6F6	44
IO96NB6F6	40
IO96PB6F6	41
IO101NB6F6	35
IO101PB6F6	36
IO102PB6F6	37
IO103NB6F6	33
IO103PB6F6	34
IO105NB6F6	28
IO105PB6F6	30
IO106NB6F6	27
IO106PB6F6	29
Bank 7	
IO107NB7F7	23
IO107PB7F7	25
IO108NB7F7	22
IO108PB7F7	24
IO110NB7F7	18

CQ352



Note

For Package Manufacturing and Environmental information, visit Resource center at http://www.microsemi.com/soc/products/rescenter/package/index.html.

CQ352	
AX500 Function	Pin Number
IO87PB4F8	171
IO89NB4F8	166
IO89PB4F8	167
IO94NB4F9	164
IO94PB4F9	165
IO95NB4F9	160
IO95PB4F9	161
IO97NB4F9	158
IO97PB4F9	159
IO99NB4F9	154
IO99PB4F9	155
IO100NB4F9	146
IO100PB4F9	147
IO101NB4F9	152
IO101PB4F9	153
IO103NB4F9/CLKEN	142
IO103PB4F9/CLKEP	143
IO104NB4F9/CLKFN	136
IO104PB4F9/CLKFP	137
Bank 5	
IO105NB5F10/CLKGN	128
IO105PB5F10/CLKGP	129
IO106NB5F10/CLKHN	122
IO106PB5F10/CLKHP	123
IO107NB5F10	118
IO107PB5F10	119
IO114NB5F11	112
IO114PB5F11	113
IO115NB5F11	110
IO115PB5F11	111
IO116NB5F11	106
IO116PB5F11	107
IO117NB5F11	104
IO117PB5F11	105
IO119NB5F11	100

CQ352	
AX500 Function	Pin Number
IO119PB5F11	101
IO121NB5F11	98
IO121PB5F11	99
IO123NB5F11	94
IO123PB5F11	95
IO125NB5F11	92
IO125PB5F11	93
Bank 6	
IO126PB6F12	86
IO127NB6F12	84
IO127PB6F12	85
IO129NB6F12	82
IO129PB6F12	83
IO131NB6F12	78
IO131PB6F12	79
IO133NB6F12	76
IO133PB6F12	77
IO134NB6F12	72
IO134PB6F12	73
IO135NB6F12	70
IO135PB6F12	71
IO137NB6F13	66
IO137PB6F13	67
IO138NB6F13	64
IO138PB6F13	65
IO139NB6F13	60
IO139PB6F13	61
IO141NB6F13	54
IO141PB6F13	55
IO142NB6F13	58
IO142PB6F13	59
IO143NB6F13	52
IO143PB6F13	53
IO145NB6F13	48
IO145PB6F13	49

CQ352	
AX500 Function	Pin Number
IO146NB6F13	46
IO146PB6F13	47
Bank 7	
IO147NB7F14	40
IO147PB7F14	41
IO148NB7F14	42
IO148PB7F14	43
IO149NB7F14	36
IO149PB7F14	37
IO151NB7F14	30
IO151PB7F14	31
IO152NB7F14	34
IO152PB7F14	35
IO153NB7F14	28
IO153PB7F14	29
IO155NB7F14	24
IO155PB7F14	25
IO157NB7F14	22
IO157PB7F14	23
IO159NB7F15	16
IO159PB7F15	17
IO160NB7F15	18
IO160PB7F15	19
IO161NB7F15	12
IO161PB7F15	13
IO163NB7F15	10
IO163PB7F15	11
IO165NB7F15	6
IO165PB7F15	7
IO167NB7F15	4
IO167PB7F15	5
Dedicated I/O	
GND	1
GND	9
GND	15

CQ352	
AX2000 Function	Pin Number
GND	21
GND	27
GND	33
GND	39
GND	45
GND	51
GND	57
GND	63
GND	69
GND	75
GND	81
GND	88
GND	89
GND	97
GND	103
GND	109
GND	115
GND	121
GND	133
GND	145
GND	151
GND	157
GND	163
GND	169
GND	176
GND	177
GND	186
GND	192
GND	198
GND	204
GND	210
GND	216
GND	222
GND	228
GND	234

CQ352	
AX2000 Function	Pin Number
GND	240
GND	246
GND	252
GND	258
GND	264
GND	265
GND	274
GND	280
GND	286
GND	292
GND	298
GND	310
GND	322
GND	330
GND	334
GND	340
GND	345
GND	352
PRA	312
PRB	311
PRC	135
PRD	134
TCK	349
TDI	348
TDO	347
TMS	350
TRST	351
VCCA	3
VCCA	14
VCCA	32
VCCA	56
VCCA	74
VCCA	87
VCCA	102
VCCA	114

CQ352	
AX2000 Function	Pin Number
VCCA	150
VCCA	162
VCCA	175
VCCA	191
VCCA	209
VCCA	233
VCCA	251
VCCA	263
VCCA	279
VCCA	291
VCCA	329
VCCA	339
VCCDA	2
VCCDA	44
VCCDA	90
VCCDA	91
VCCDA	116
VCCDA	117
VCCDA	130
VCCDA	131
VCCDA	132
VCCDA	148
VCCDA	149
VCCDA	174
VCCDA	178
VCCDA	221
VCCDA	266
VCCDA	268
VCCDA	293
VCCDA	294
VCCDA	307
VCCDA	308
VCCDA	309
VCCDA	327
VCCDA	328

CG624	
AX1000 Function	Pin Number
Bank 0	
IO00NB0F0	F8
IO00PB0F0	F7
IO02NB0F0	G7
IO02PB0F0	G6
IO04NB0F0	E9
IO04PB0F0	D8
IO06NB0F0	G9
IO06PB0F0	G8
IO07PB0F0	B6
IO08NB0F0	F10
IO08PB0F0	F9
IO09PB0F0	C7
IO10NB0F0	H8
IO10PB0F0	H7
IO11NB0F0	D10
IO11PB0F0	D9
IO12NB0F1	B5
IO12PB0F1	B4
IO13NB0F1	A7
IO13PB0F1	A6
IO14NB0F1	C9
IO14PB0F1	C8
IO15PB0F1	B7
IO16NB0F1	A5
IO16PB0F1	A4
IO17NB0F1	A9
IO17PB0F1	B9
IO18NB0F1	D12
IO18PB0F1	D11
IO20NB0F1	B11
IO20PB0F1	B10
IO21NB0F1	A11
IO21PB0F1	A10
IO22NB0F2	H10
IO22PB0F2	H9

CG624	
AX1000 Function	Pin Number
IO23NB0F2	E11
IO23PB0F2	F11
IO24NB0F2	D7
IO24PB0F2	E7
IO25PB0F2	B12
IO26NB0F2	H11
IO26PB0F2	G11
IO27NB0F2	C11
IO27PB0F2	B8
IO28NB0F2	J13
IO28PB0F2	K13
IO29NB0F2	J8
IO29PB0F2	J7
IO30NB0F2/HCLKAN	G13
IO30PB0F2/HCLKAP	G12
IO31NB0F2/HCLKBN	C13
IO31PB0F2/HCLKBP	C12
Bank 1	
IO32NB1F3/HCLKCN	G15
IO32PB1F3/HCLKCP	G14
IO33NB1F3/HCLKDN	B14
IO33PB1F3/HCLKDP	B13
IO34NB1F3	G16
IO34PB1F3	H16
IO35NB1F3	C17
IO35PB1F3	B18
IO36NB1F3	H18
IO36PB1F3	H15
IO37NB1F3	H13
IO38NB1F3	E15
IO38PB1F3	F15
IO39NB1F3	D14
IO39PB1F3	C14
IO40NB1F3	D16
IO40PB1F3	D15
IO41NB1F4	F16

CG624	
AX1000 Function	Pin Number
IO42NB1F4	G21
IO42PB1F4	G20
IO43NB1F4	A16
IO43PB1F4	A15
IO44NB1F4	A20
IO44PB1F4	A19
IO45NB1F4	B17
IO45PB1F4	B16
IO46NB1F4	G17
IO46PB1F4	H17
IO47NB1F4	A17
IO48NB1F4	C19
IO48PB1F4	C18
IO49NB1F4	B20
IO49PB1F4	B19
IO50NB1F4	H20
IO50PB1F4	H19
IO51NB1F4	A22
IO51PB1F4	A21
IO52NB1F4	C21
IO52PB1F4	C20
IO53NB1F4	B22
IO53PB1F4	B21
IO54NB1F5	J18
IO54PB1F5	J19
IO55NB1F5	D18
IO55PB1F5	D17
IO56NB1F5	F20
IO56PB1F5	F19
IO58NB1F5	E17
IO58PB1F5	F17
IO60NB1F5	D20
IO60PB1F5	D19
IO62NB1F5	E18
IO62PB1F5	F18
IO63NB1F5	G19

CG624	
AX2000 Function	**Pin Number**
GND	M11
GND	M12
GND	M13
GND	M14
GND	M15
GND	N11
GND	N12
GND	N13
GND	N14
GND	N15
GND	P11
GND	P12
GND	P13
GND	P14
GND	P15
GND	R11
GND	R12
GND	R13
GND	R14
GND	R15
GND	T21
GND	T23
GND	T3
GND	T5
GND	V1
GND	V25
GND	V5
PRA	F13
PRB	A13
PRC	AB12
PRD	AE13
TCK	F5

*Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*

CG624	
AX2000 Function	**Pin Number**
TDI	C5
TDO	F6
TMS	D6
TRST	E6
VCCA	AB20
VCCA	F22
VCCA	F4
VCCA	J17
VCCA	J9
VCCA	K10
VCCA	K11
VCCA	K15
VCCA	K16
VCCA	L10
VCCA	L16
VCCA	R10
VCCA	R16
VCCA	T10
VCCA	T11
VCCA	T15
VCCA	T16
VCCA	U17
VCCA	U9
VCCA	Y4
VCCDA	A12
VCCDA	A14
VCCDA	AA13
VCCDA	AA15
VCCDA	AA20
VCCDA	AA7
VCCDA	AB13
VCCDA	AC11

*Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*

CG624	
AX2000 Function	**Pin Number**
VCCDA	AD11
VCCDA	AD4
VCCDA	AE12
VCCDA	AE17
VCCDA	B15
VCCDA	C15
VCCDA	C6
VCCDA	D13
VCCDA	E13
VCCDA	E19
VCCDA	F21
VCCDA	G10
VCCDA	G5
VCCDA	N21
VCCDA	N5
VCCDA	W21
VCCIB0	A3
VCCIB0	B3
VCCIB0	C4
VCCIB0	D5
VCCIB0	J10
VCCIB0	J11
VCCIB0	K12
VCCIB1	A23
VCCIB1	B23
VCCIB1	C22
VCCIB1	D21
VCCIB1	J15
VCCIB1	J16
VCCIB1	K14
VCCIB2	C24
VCCIB2	C25

*Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.*

4 – Datasheet Information

List of Changes

The following table lists critical changes that were made in the current version of the document.

Revision	Changes	Page
Revision 18 (March 2012)	Table 2-1 • Absolute Maximum Ratings was updated to correct the maximum DC core supply voltage (VCCA) from 1.6 V to 1.7 V (SAR 36786). The maximum input voltage (VI) was corrected from 3.75 V to 4.1 V (SAR 35419).	2-1
	Values for tristate leakage current IOZ, and IIH and IIL were added to Table 2-3 • Standby Current (SARs 35774, 32021).	2-2
	Figure 2-2 • VCCPLX and VCOMPLX Power Supply Connect was updated to correct the units for the resistance from "W" to Ω (SAR 36415).	2-9
	In the Introduction to the "User I/Os" section, the following sentence was added to clarify the slew rate setting (SAR 34943): The slew rate setting is effective for both rising and falling edges.	2-11
	Figure 2-3 • Use of an External Resistor for 5 V Tolerance was revised to show the VCCI and GND clamp diodes. The explanatory text above the figure was revised as well (SAR 34942).	2-13
	EQ 3 for 5 V tolerance was corrected to change Vdiode from 0.6 V to 0.7 V (SAR 36786).	2-13
	Additional information was added to the "Using the Weak Pull-Up and Pull-Down Circuits" section to clarify how the weak pull-up and pull-down resistors are physically implemented (SAR 34945).	2-17
	The description for the C_{INCLK} parameter in Table 2-18 • Input Capacitance was changed from "Input capacitance on clock pin" to "Input capacitance on HCLK and RCLK pin" (SAR 34944).	2-21
	Table 2-19 • I/O Input Rise Time and Fall Time* is new (SAR 34942).	2-21
	The minimum VIL for 1.5 V LVCMOS and PCI was corrected from –0.5 to –0.3 in Table 2-29 • DC Input and Output Levels and Table 2-33 • DC Input and Output Levels (SAR 34358).	2-38, 2-40
	Support for simulating the GCLR/ GPSET feature in the Axcelerator Family was added in Libero software v9.0 SPI1. Reference to the section explaining this in the *Antifuse Macro Library Guide* was added to the "R-Cell" section (SAR 26413).	2-58
	The enable signal in Figure 2-32 • R-Cell Delays was corrected to show it is active low rather than active high (SAR 34946).	2-59
Revision 17 (September 2011)	The versioning system for datasheets has been changed. Datasheets are assigned a revision number that increments each time the datasheet is revised. The "Axcelerator Family Device Status" table indicates the status for each device in the device family.	iii
	The "Features" section, "Programmable Interconnect Element" section, and "Security" section were revised to clarify that although no existing security measures can give an absolute guarantee, Microsemi FPGAs implement the best security available in the industry (SAR 32865).	i, 1-1, 2-108